



UNIVERSAL SOLVENT CLEANER

DESCRIPTION

Almit Universal is a high flash point, low toxic solvent designed for the removal of solder paste and uncured surface mount adhesives from stencils, squeegees, tools and misprinted circuit boards. It is equally suitable for removing post wave soldering or reflowed flux residues from assemblies. Almit Universal was developed as a multipurpose electronic/electrical assembly cleaning agent, however it can also be used to remove oil, grease and other soils from production equipment.

USES

Almit Universal should be used to clean the following contaminants from stencils, PCB's, process equipment and work surfaces:

- solder paste
- solder paste flux residues
- wave solder flux residues
- uncured adhesives
- process oils and greases

Almit Universal can be used as required in immersion, spray, ultrasonic or bench top cleaning applications. It is particularly useful for cleaning dry solder paste and uncured surface mount adhesives from stencils, printing blades, tools and PCB's.

FEATURES

BENEFITS

High solvency power	Fast cleaning times
Versatile solvent	One solvent to clean all process items
Quick film-free drying	Low solvent usage/carry out
Readily biodegradable	Small spills easy to deal with



CHEMICAL / MATERIAL PROPERTIES

Density at 20°C	1.08
Vapour Pressure at 20°C	<0.1mm/Hg
Solubility in Water at 20°C	Virtually Insoluble
Flash Point	Above 80°C (closed cup)
Odour	Virtually odour free

AVAILABILITY

Almit Universal is available in 5, 25 litre drums, and various size trigger action spray bottles for hand cleaning applications.

NOTE

Almit Universal may soften some bitumen and rubber seals found on certain cleaning equipment. It should also be tested for suitability prior to use on polystyrene, acetates and lacquers. For specialist application advice call ALMIT on 01342 822844.